

Product Summary

V_{RRM} (V)	I_O (A)	V_F max(V) @ +25°C	I_R max (mA) @ +25°C
1000	1.0	1.15V	0.01

Description and Applications

This 1.0A DiodeStar Rectifier has been designed for use in general purpose rectifier. It is ideally suited for use as a:

- Bridge Rectifier

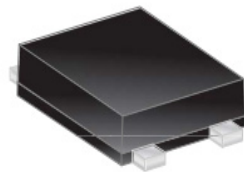
Features and Benefits

- Low reverse leakage ensuring greater stability at higher temperatures
- Low forward voltage (V_F) minimises conduction losses and improving efficiency.
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**

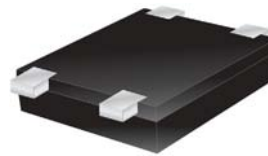
Mechanical Data

- Case: T-MiniDIP
- Case Material: Molded Plastic "Green" Molding Compound, UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish – Matte Tin over Copper Lead Frame, Solderable per MIL-STD-202, Method 208
- Polarity: See Diagram
- Weight: 0.092 grams (approximate)

T-MiniDIP



Top View



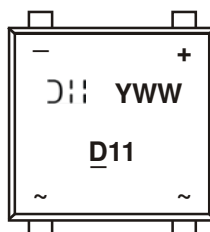
Bottom View

Ordering Information (Note 4)

Part Number	Case	Packaging
DSRHD10-13	T-MiniDIP	5000/Tape & Reel

- Notes:
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information



- DXX = Product Type Marking Code,
(XX = 11 or 1A)
 = Manufacturers' Code Marking
 YWW = Date Code Marking
 Y = Last Digit of Year (ex: 2 = 2012)
 WW = Week Code (01 ~ 53)

Maximum Ratings (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V_{RRM}	1000	V
Working Peak Reverse Voltage	V_{RWM}		
DC Blocking Voltage	V_{RM}		
Average Rectified Output Current	I_O	1.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load (Per Diode)	I_{FSM}	30	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Ambient (Note 5)	$R_{\theta JA}$	107	$^\circ\text{C/W}$
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +150	$^\circ\text{C}$

Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Typ	Max	Unit	Test Condition
Forward Voltage (Per Diode)	V_F	0.88	0.95	V	$I_F = 0.4\text{A}, T_J = +25^\circ\text{C}$
		0.92	1.15		$I_F = 1.0\text{A}, T_J = +25^\circ\text{C}$
Reverse Current (Note 6) (Per Diode)	I_R	0.08	10	μA	$V_R = 1000\text{V}, T_J = +25^\circ\text{C}$
		5	150		$V_R = 1000\text{V}, T_J = +125^\circ\text{C}$

Notes: 5. Device mounted on FR-4 substrate, 1.0"x1.0", 2oz, single-sided, PC boards with 0.2"x0.25" copper pad.
6. Short duration pulse test used to minimize self-heating effect.

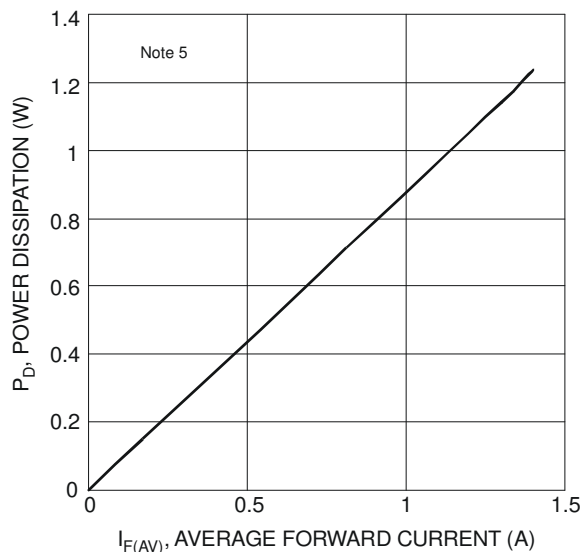


Figure 1 Forward Power Dissipation

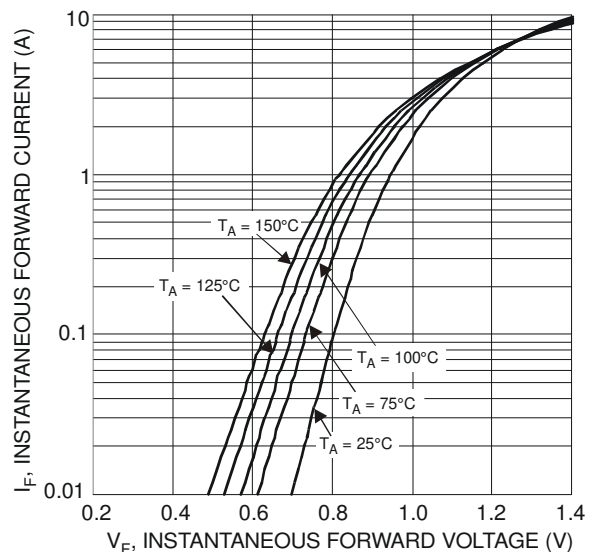


Figure 2 Typical Forward Characteristics

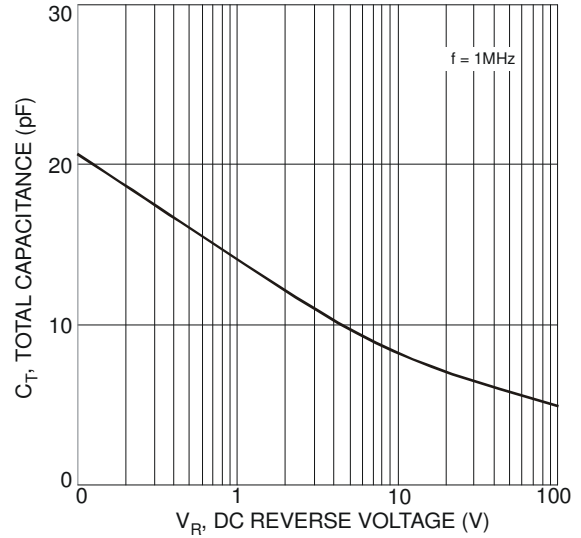
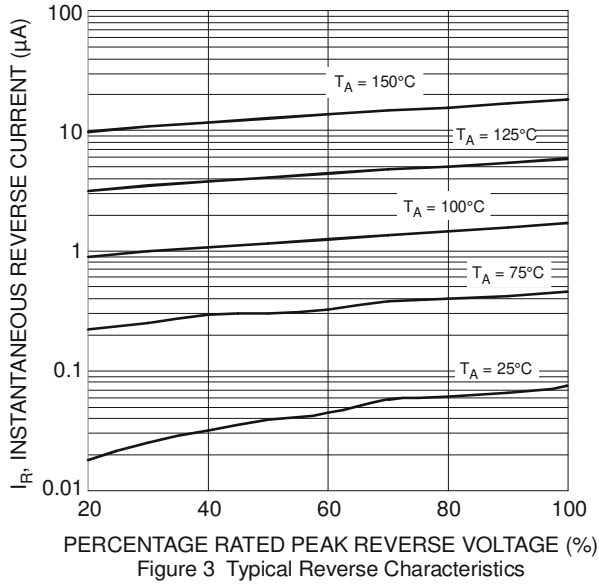


Figure 4 Total Capacitance vs. Reverse Voltage

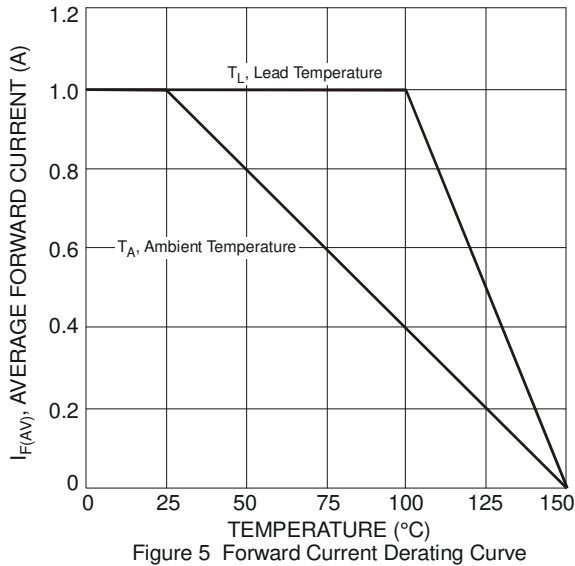


Figure 5 Forward Current Derating Curve

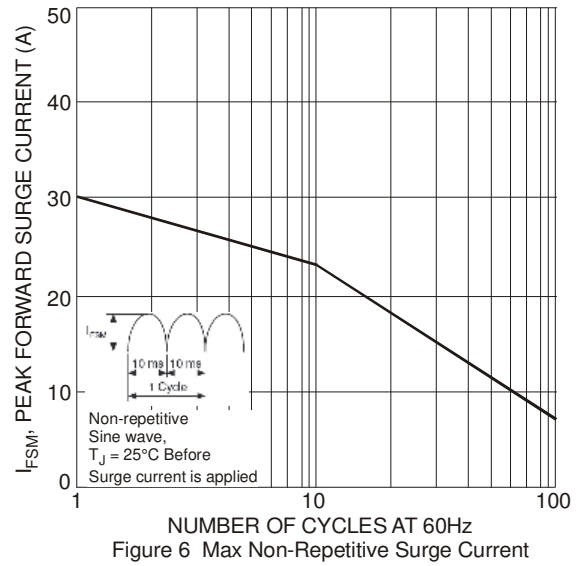
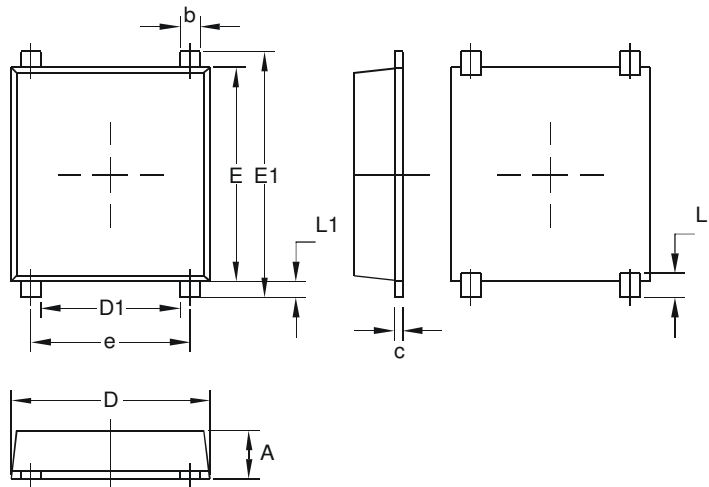


Figure 6 Max Non-Repetitive Surge Current

Package Outline Dimensions

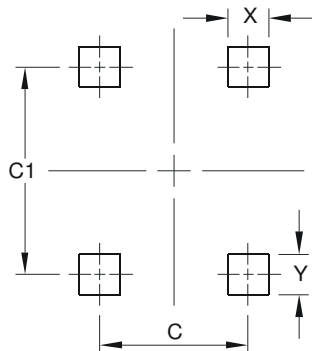
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.



T-MiniDIP		
Dim	Min	Max
A	1.15	1.27
b	0.60	0.70
c	0.15	0.25
D	4.90	5.10
D1	3.20	3.50
E	5.30	5.50
E1	6.00	6.40
e	3.90	4.10
L	0.25	0.80
L1	0.25	0.55
All Dimensions in mm		

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
C	4.00
C1	5.60
X	0.75
Y	0.85

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